

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Mou-Shiung Lin	10/16/2008
RECEIVING PARTY DATA	
Name:	MEGICA Corporation
Street Address:	Room 301/302, No. 47, Park 2nd Rd.
Internal Address:	Science Based Industrial Park
City:	Hsinchu
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	10434142
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	MEG02-008CCC
NAME OF SUBMITTER:	Stephen B Ackerman
Total Attachments: 2 source=MEG02-008CCC#page1.tif source=MEG02-008CCC#page2.tif	

CH \$40.00 10434142

For U.S. and/or Foreign Rights
For Application or U.S. Patent
By Inventor(s) or Present Owner

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNOR:

MOU-SHUNG LIN
Type or print name of ASSIGNOR

28 Ginsan 10th Street
Address

Hsin-Chu, Taiwan, Republic of China

Republic of China
Nationality

hereby sell, assign and transfer to

ASSIGNEE:

MEGICA CORPORATION
Room 301/302, No. 47, Park 2nd Rd.
Science Based Industrial Park
Hsinchu, Taiwan, R.O.C.
Taiwan, R.O.C.
Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

- the entire right, title and interest
 an undivided _____ percent (___%) interest for the United States and its territorial possessions

(check the following box if foreign rights are also to be assigned)

- and in all foreign countries

in and to any and all improvements which are disclosed in the invention entitled:

Method Of Wire Bonding Over Active Area Of A Semiconductor Circuit

and which is found in

- (a) U.S. patent application executed on even date herewith
- (b) U.S. patent application executed on
- (c) U.S. application serial no. 10/434,142 filed on 5/8/03
- (d) U.S. patent no. _____ issued _____
(also check (e) if foreign application(s) is also being assigned)
- (e) and any legal equivalent thereof in a foreign country, including the right to claim priority

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute, thereof, and as to letters patent any re-issue or re-examination thereof.

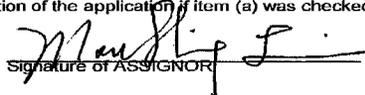
ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I / We have signed this

Oct. 16, 2008 (Date of signing)

WARNING Date of signing must be the same as the date of execution of the application if item (a) was checked above


Signature of ASSIGNOR

If ASSIGNOR is a legal entity complete the following information

Type or print the name of the above person authorized to sign on behalf of ASSIGNOR

Title

Note: No witnessing, notarization or legalization is necessary, if the assignment is notarized or legalized then it will only be prima facie evidence (35 USC 261). Use next page if notarization is desired.

Notarization of Legalization Page Added.